

# THGEM Operation in Ne & Ne-Mixtures\*

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\* Work pursued within the framework of CERN-RD51

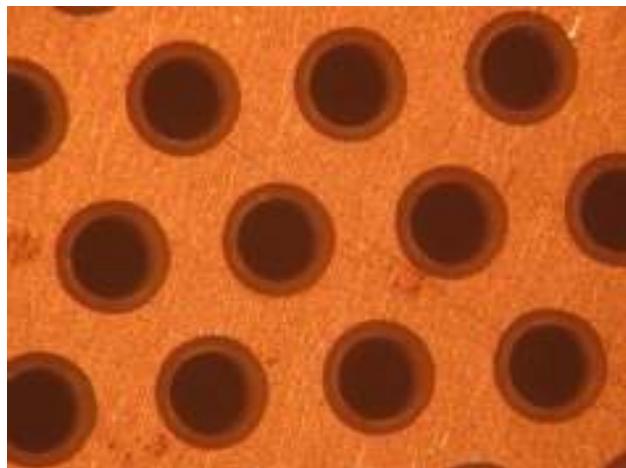
For more info: THGEM in Ne & Ne/CH<sub>4</sub>,  
CORTESI *et al.* submitted to JINST  
(arXiv:0905.2916); RD51-Publications.

# Thick-GEM (THGEM) multipliers

Manufactured by standard PCB techniques of precise drilling in G-10 (and other materials) and Cu etching.

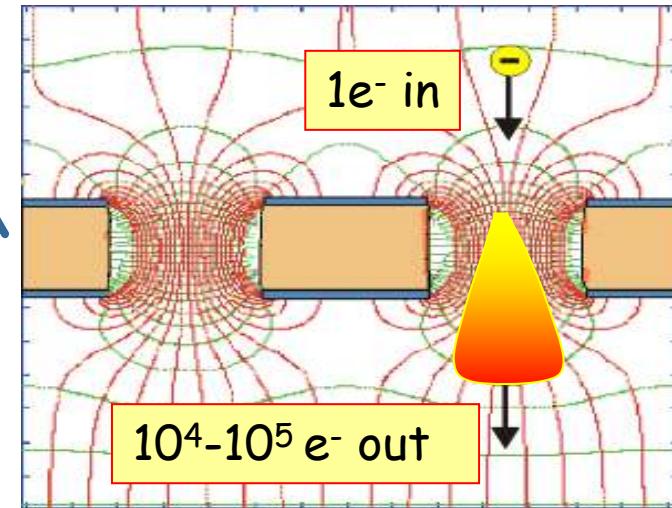
Other groups independently developed similar structures:

- ) Optimized GEM: L. Periale et al., NIM A478 (2002) 377.
- ) LEM: P. Jeanneret, PhD thesis, 2001.



0.1 mm rim  
to prevent  
discharges

$E \sim 40 \text{ kV/cm}$



Hole diameter

$d = 0.3 - 1 \text{ mm}$

Distance between holes

$a = 0.7 - 7 \text{ mm}$

Plate thickness

$t = 0.4 - 3 \text{ mm}$

**Effective single-photon detection**  
**8ns RMS time resolution**  
**>MHz/mm<sup>2</sup> rate capability**  
**Broad gas & pressure selection**  
**Sub-mm position resolution**  
**Cryogenic operation: OK**

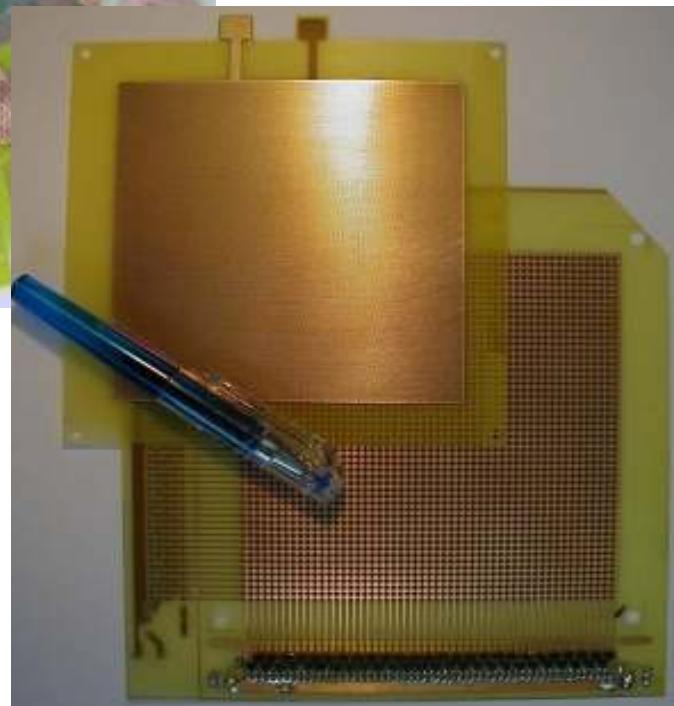
THGEM Recent review by BRESKIN *et al.*  
<http://dx.doi.org/10.1016/j.nima.2008.08.062>

# The THGEMs at Weizmann

3x3 cm<sup>2</sup>: basic studies, many geometries



10x10 cm<sup>2</sup>: 2D imaging



Future: 30x30 cm<sup>2</sup>



# Gain: Single THGEM ( $t=0.8\text{ mm}$ )

single THGEM ( $t = 0.8 \text{ mm}$ ,  $d = 0.5 \text{ mm}$ ,  $a = 1 \text{ mm}$ ,  $\text{rim} = 0.1 \text{ mm}$ )

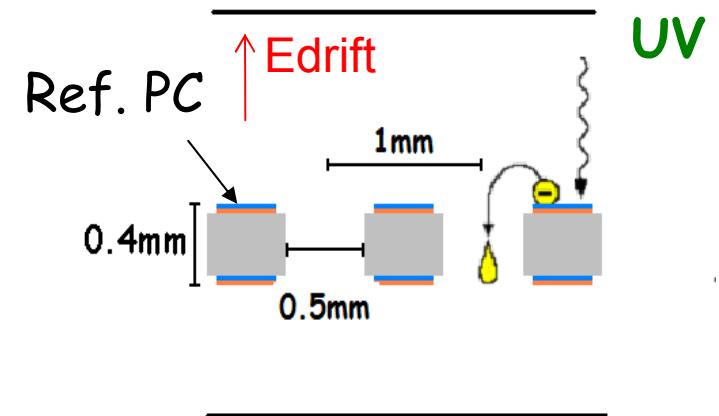
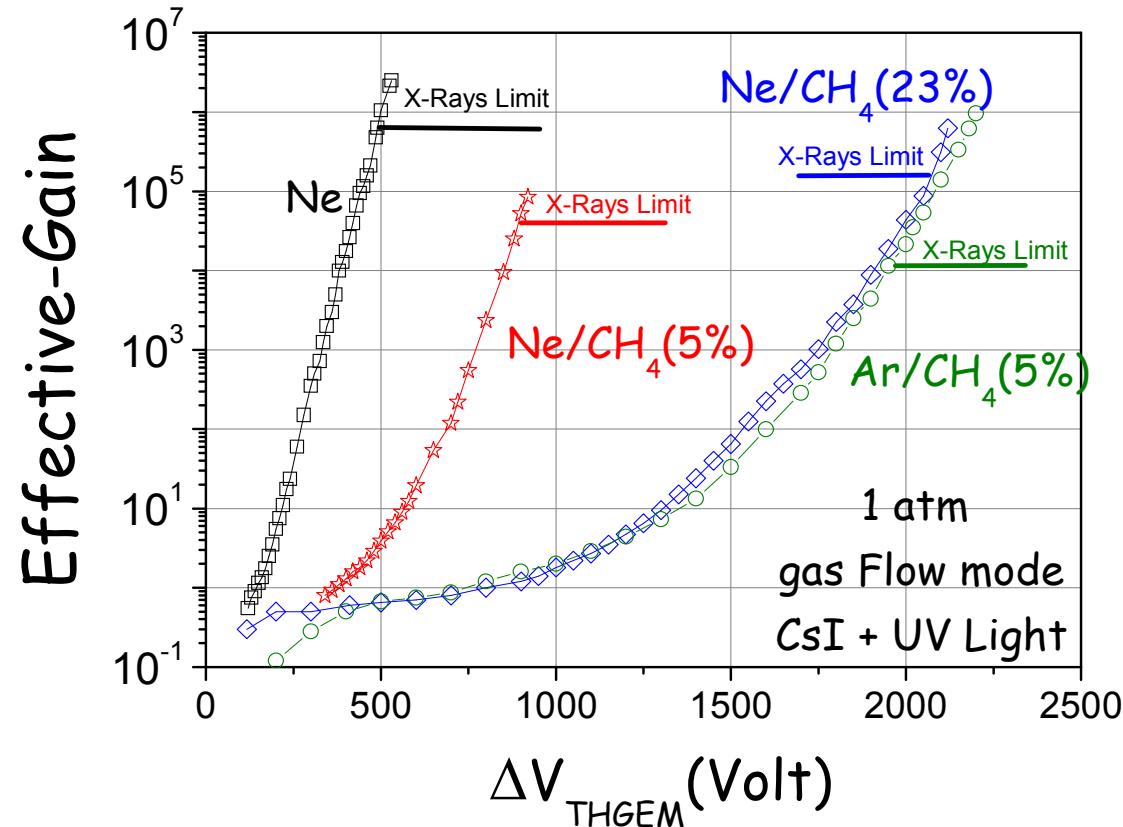
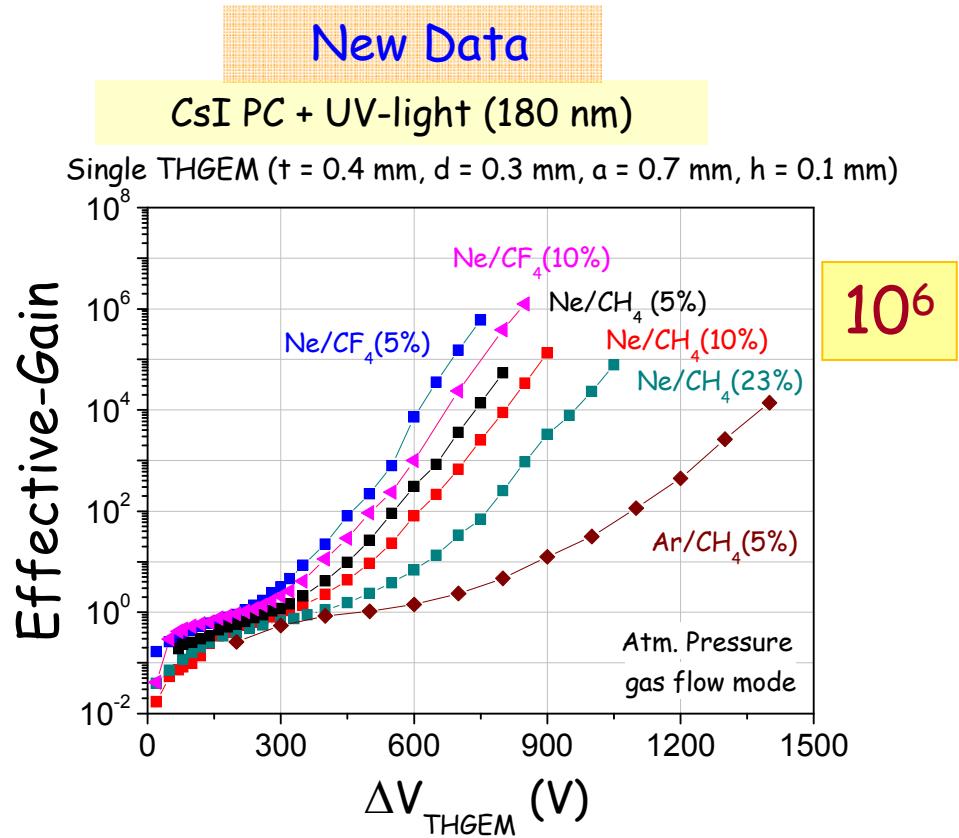
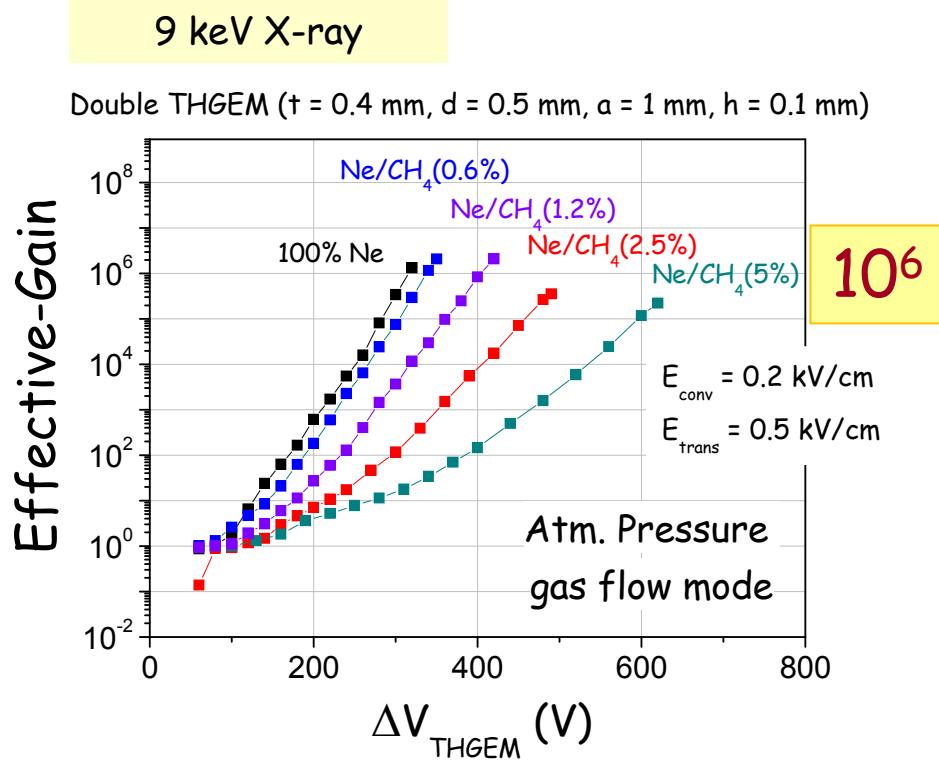


Photo- $e^-$  extraction from  
Reflective  
photocathode &  
focusing by dipole field  
requires  
 $E_{\text{drift}} = 0 \text{ kV/cm}$

High gain in Ne and Ne-methane  
low voltage @ low CH<sub>4</sub> concentrations

In Ne-Mixtures Larger dynamic range compared to Ar/CH<sub>4</sub>

# Gain: Single/Double THGEM ( $t=0.4\text{ mm}$ )



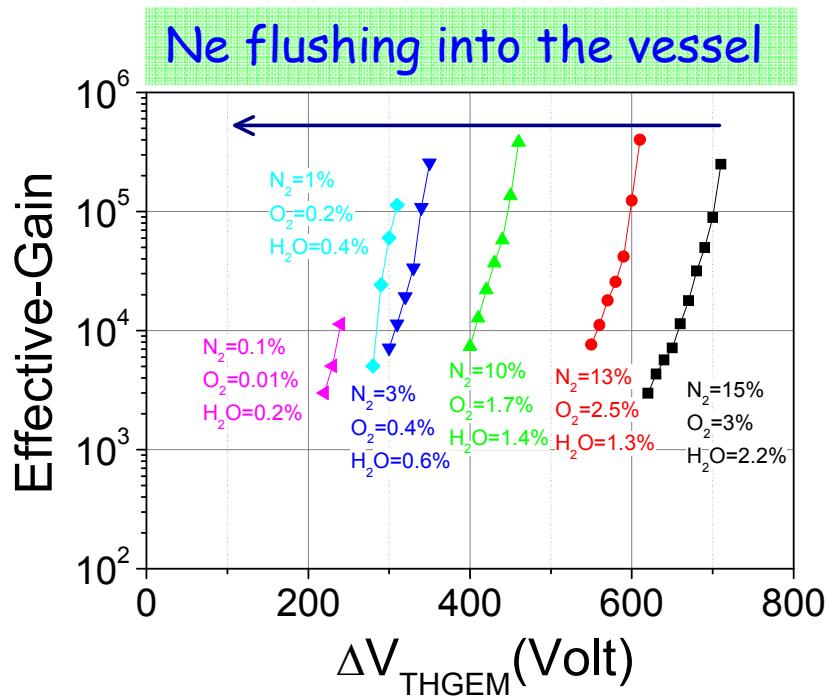
Very high gain in Ne and Ne mixtures, even with X-rays

At very low voltages !!

2-THGEM 100% Ne: Gain  $10^6$  @  $\sim 300\text{V}$

1-THGEM Ne/CF<sub>4</sub>(10%): Gain  $> 10^6$  @  $\sim 800\text{V}$

# THGEM operation: Gas Impurities

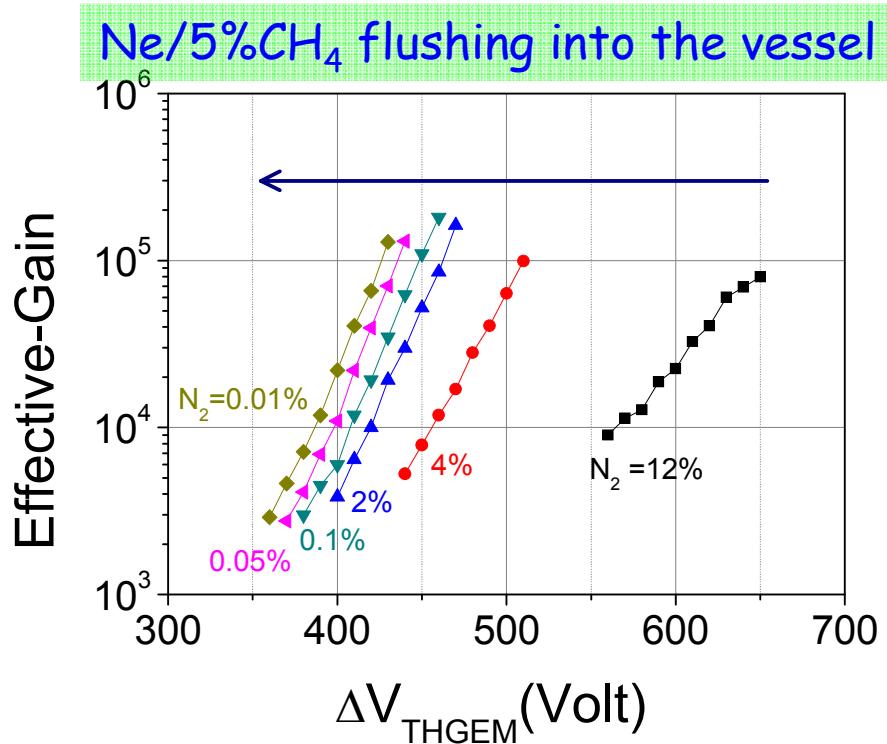


As the impurities are removed:

- 1) Lower operational Voltages
- 2) In Ne → Max. Gain drops  
In Ne/CH<sub>4</sub> → Same Max. Gain

Double-THGEM detector  
(t=0.4mm, d=0.5mm, a=1mm, rim=0.12mm)  
Gain measured with X-rays (6 keV)

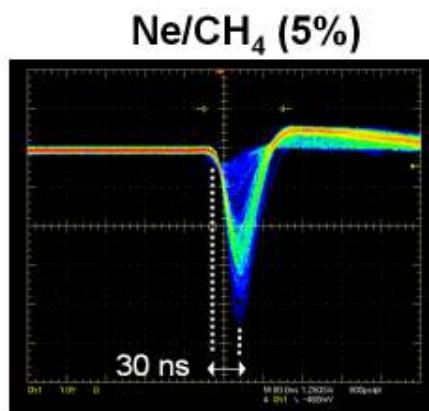
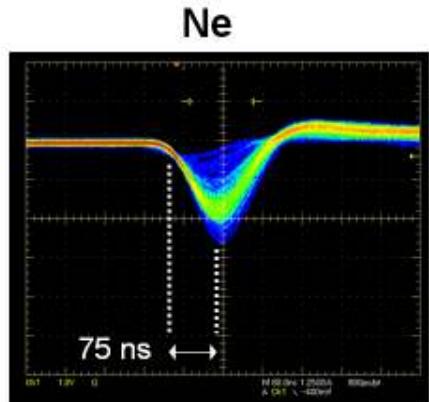
In the figs: **N<sub>2</sub>** represents all impurities  
(N<sub>2</sub>, H<sub>2</sub>O, O<sub>2</sub>, Ar etc.)  
'Purification' by continuous  
Ne gas flow (20 hours)



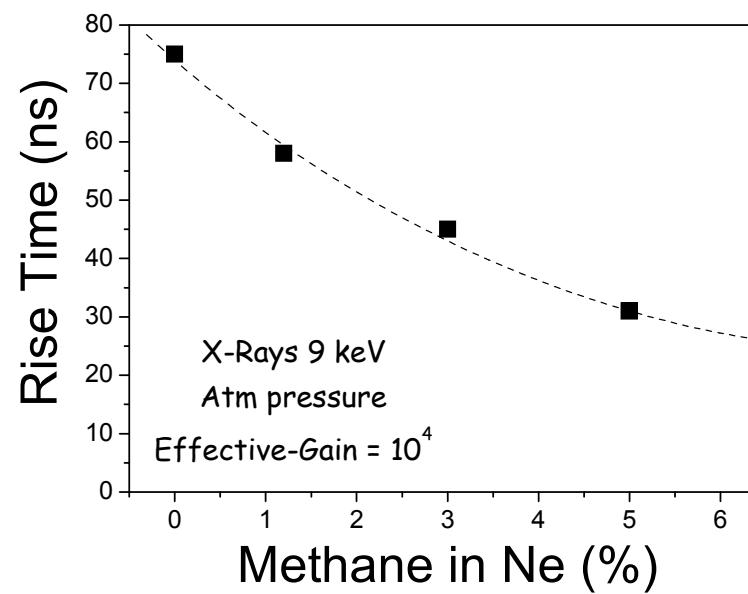
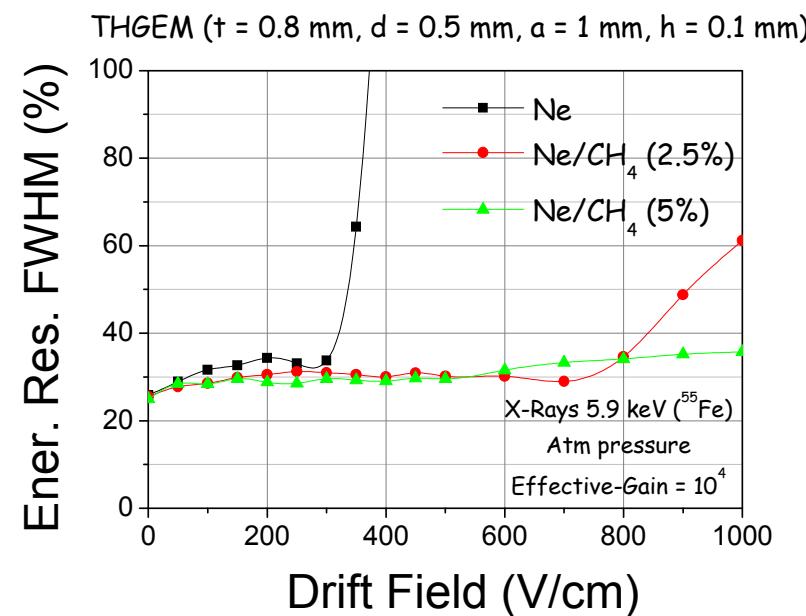
**Impurities affect gain in Ne but not in Ne/CH<sub>4</sub>!**

# Energy Resolution & rise-time

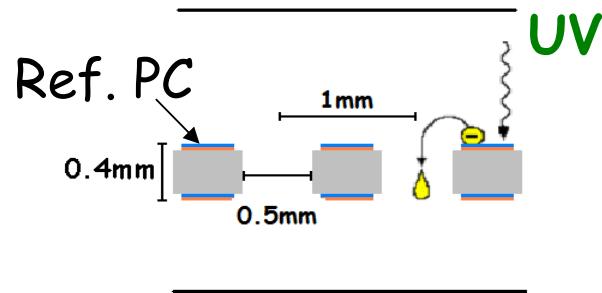
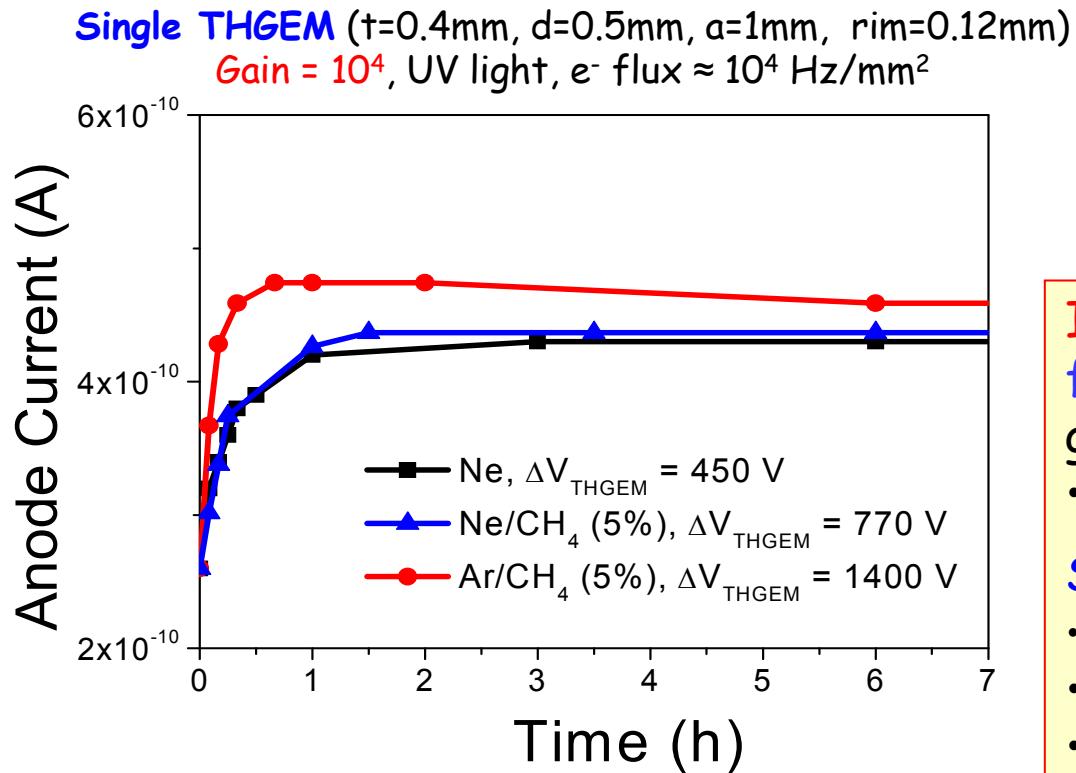
THGEM signals w fast amp



Increasing %CH<sub>4</sub> →  
higher voltages &  
faster avalanches



# Long-Term Stability (after gas stabilization)



Insulator Charging up → few hours of stabilization  
gain variation  $\sim x2$ , depends on:

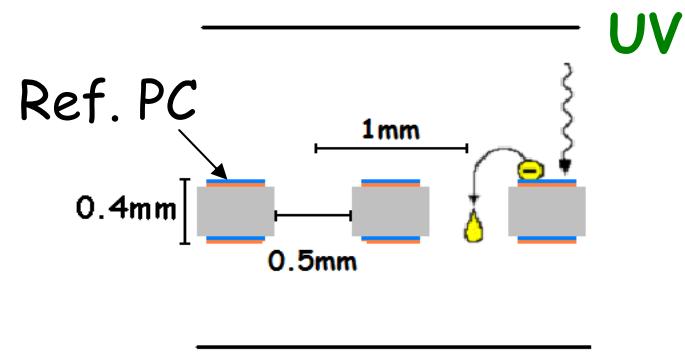
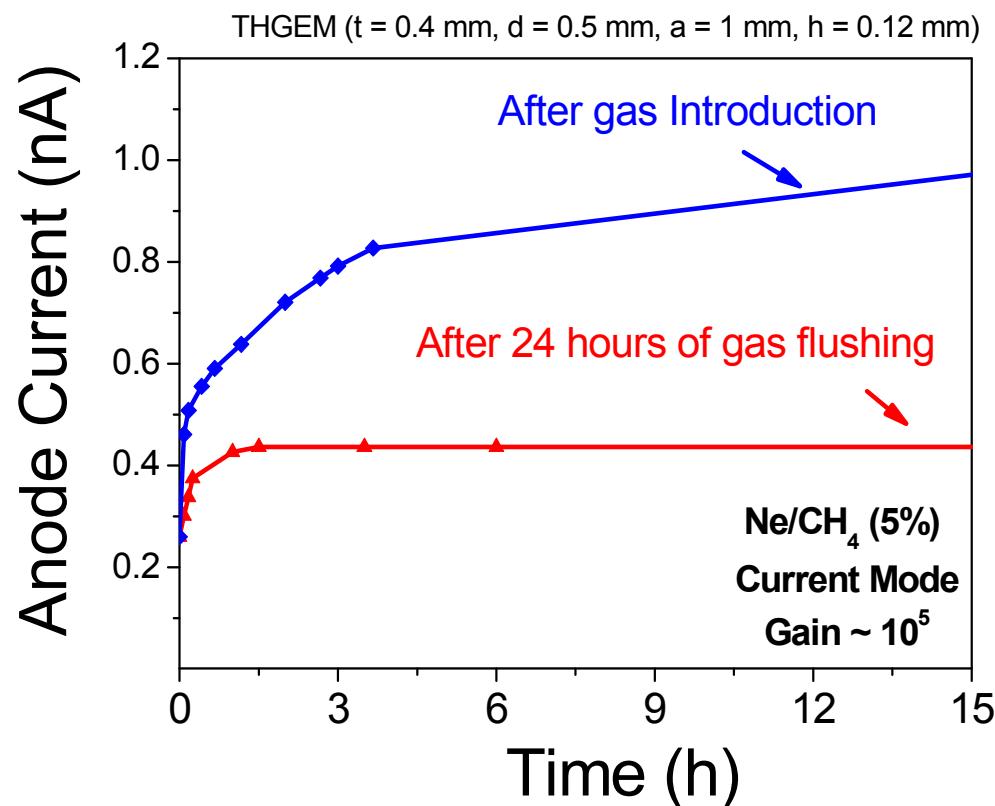
- voltages, currents, gas, materials

Stabilization time function of:

- Total gain (potentials)
- Counting rate (current)
- Material & hole-geometry
- Production method (adsorbed chemicals)
- Gas & purity

# Long-Term Stability: Gas Impurity

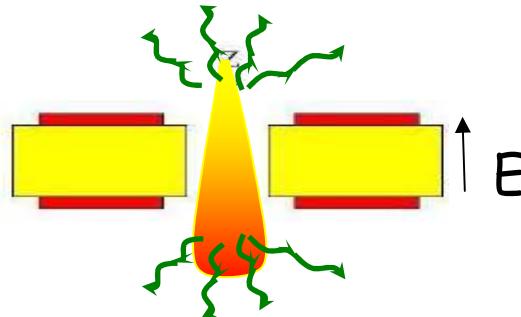
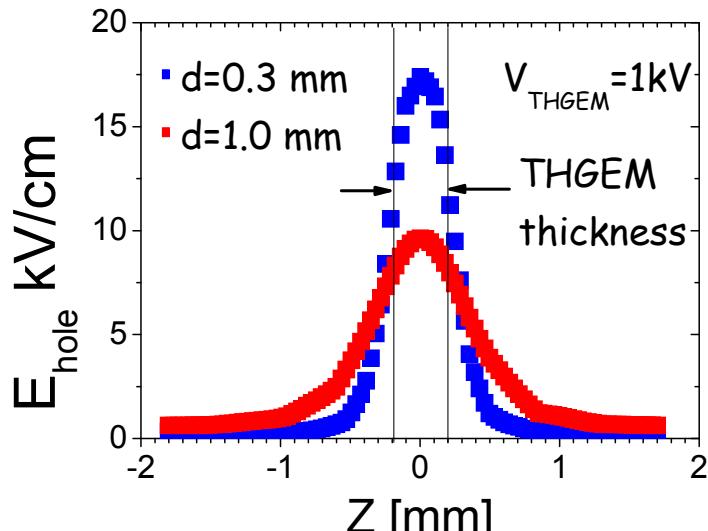
Single THGEM ( $t=0.4\text{mm}$ ,  $d=0.5\text{mm}$ ,  $a=1\text{mm}$ ,  $\text{rim}=0.12\text{mm}$ )  
Gain =  $10^4$ , UV light,  $e^-$  flux  $\approx 10^4 \text{ Hz/mm}^2$



Impurities effects on long-term stability:  
- ) Higher variation of Gain  
- ) Longer Stabilization time

# THGEM - hole diameter & avalanche

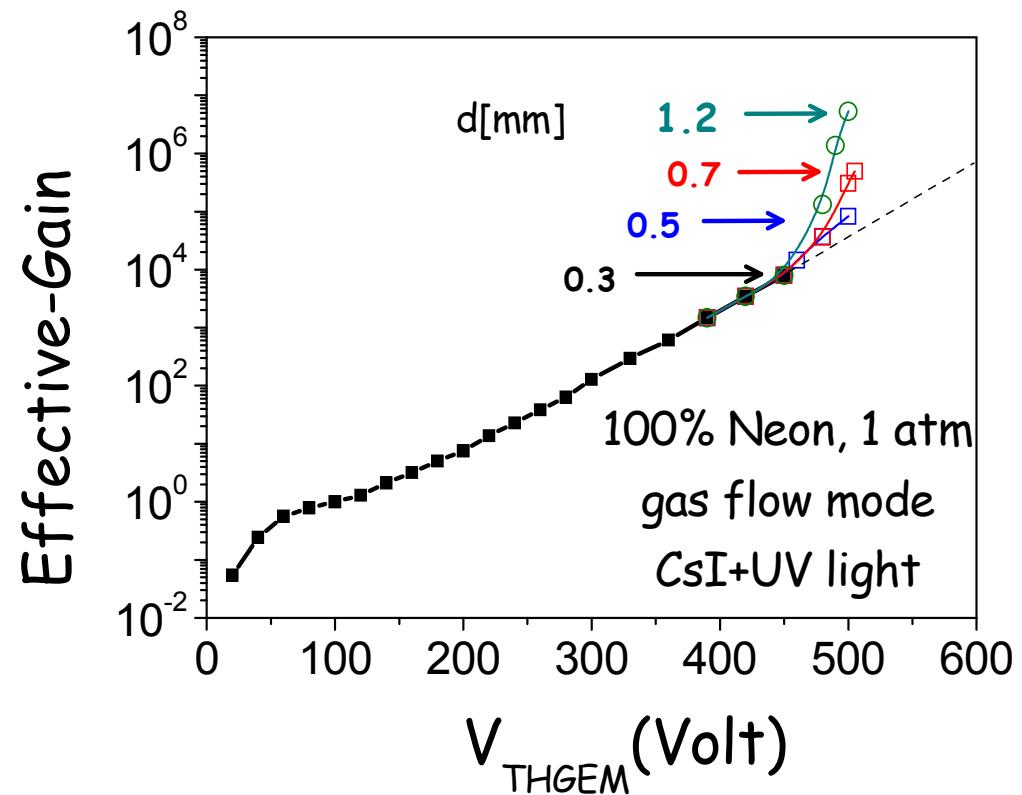
Maxwell Software calculation



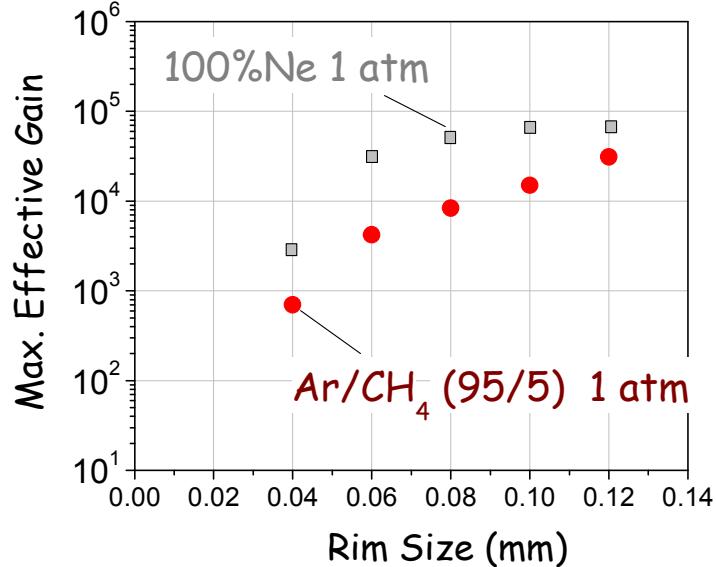
Avalanche & photons  
Outside the hole.

Ne, Ar have energetic photons  
Need to optimize sizes and  
fields according to the gas.

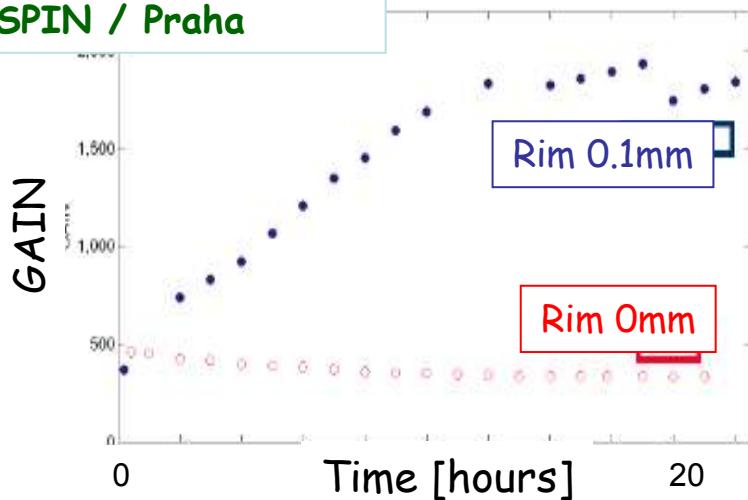
Avalanche de-confinement  
(Field extends out of the THGEM holes)  
Photon-induced secondary effects depend  
on THGEM geometry and filling gas.



# THGEM - Rim effect

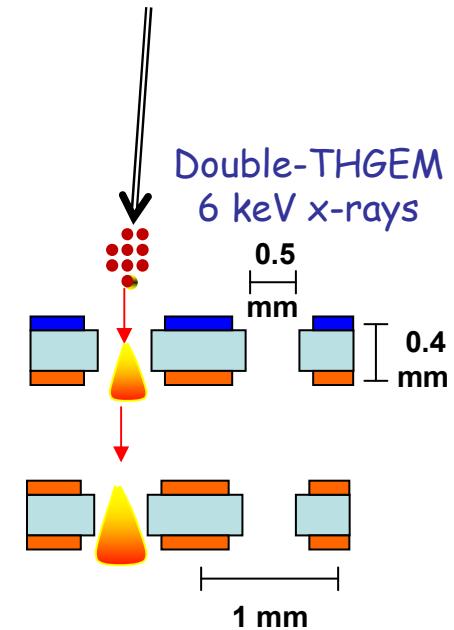


From: J. Polak/Trieste  
@ SPIN / Praha



THGEMs produced by chemical etching (no mask) @ PE, Israel

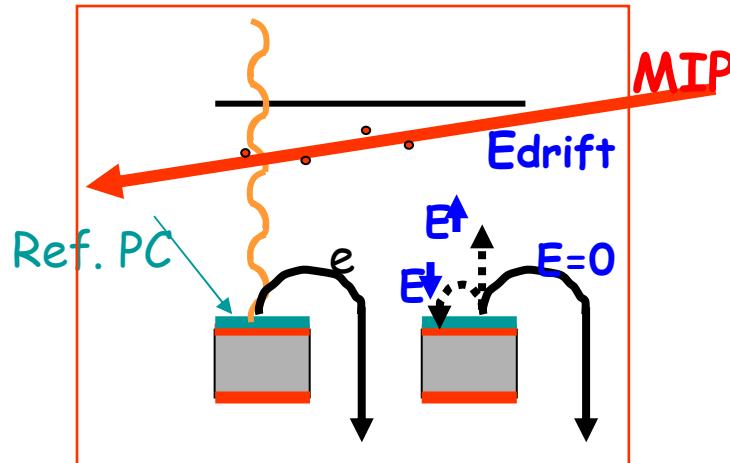
Larger rim →  
Higher voltages &  
Higher gains



But: Larger rim →  
up-charging  
& longer stabilization

Further R&D in progress @  
CERN-RD51  
e.g.: zero rim → no up charging,  
but @ lower gain

# Photon detectors for RICH: reflective CsI PC deposited on the THGEM Photoelectron collection efficiency

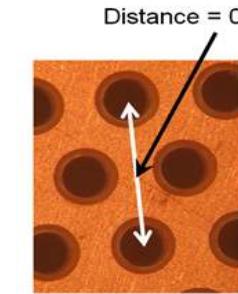


Focusing is done by the hole dipole field.

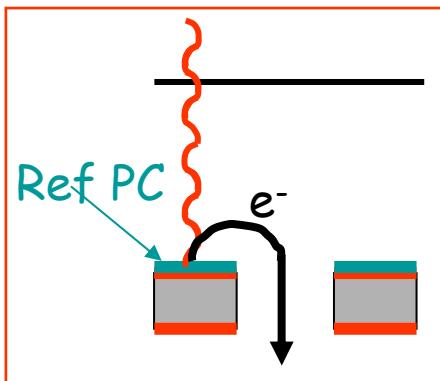
- Maximum efficiency obtained in Ar/5%CH<sub>4</sub> at  $E_{\text{drift}} = 0$ .
- Slightly reversed  $E_{\text{drift}}$  (50-100V/cm) => good photoelectron collection & low sensitivity to MIPs (e.g. proved with multi-GEM detectors of PHENIX)

Currently R&D for upgrade of COMPASS & ALICE RICH

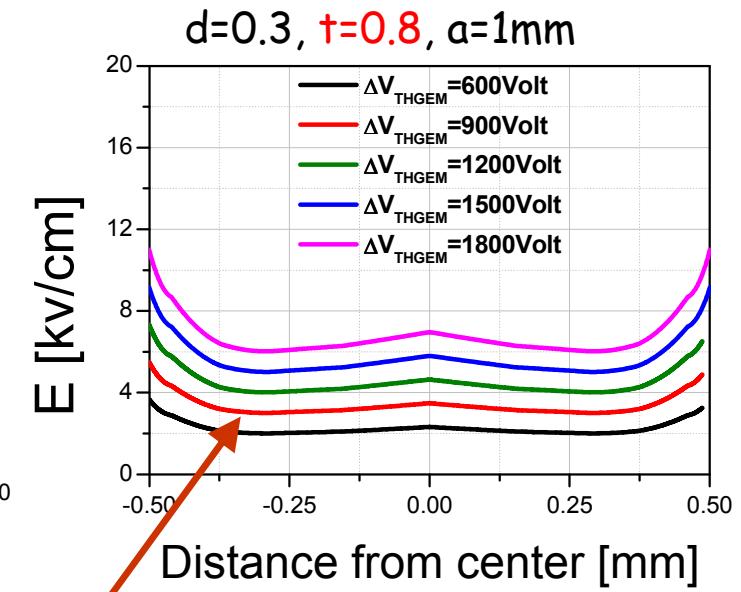
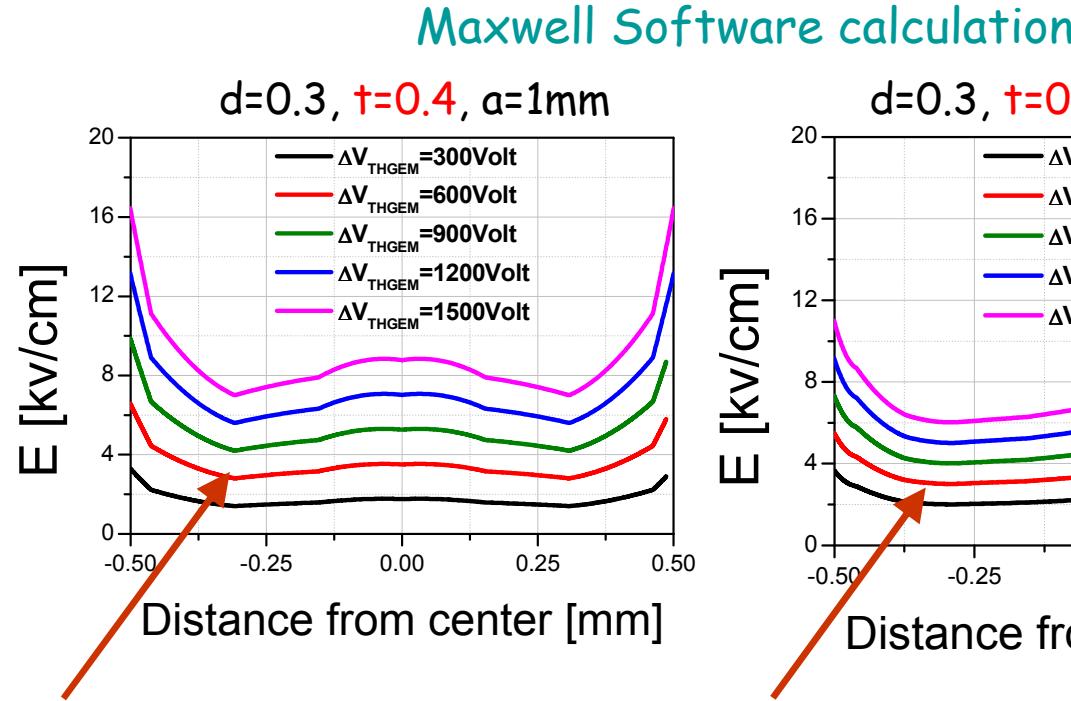
# PC Electric Field and $e^-$ Extraction



The hole dipole field  
creates electric  
field on the PC  
surface



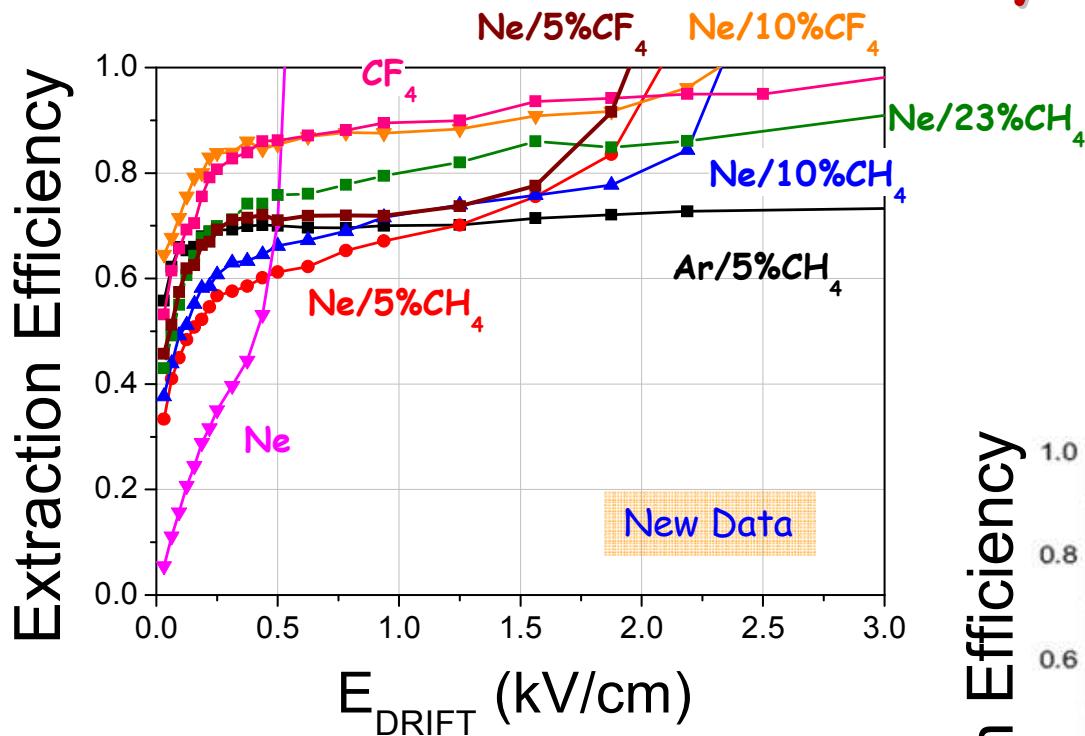
In Ne/5%CF<sub>4</sub> @ gain~10<sup>6</sup> (1-THGEM)  
typ.  $V_{THGEM} \sim 800$  V  $\rightarrow E > 3.5$ kV/cm



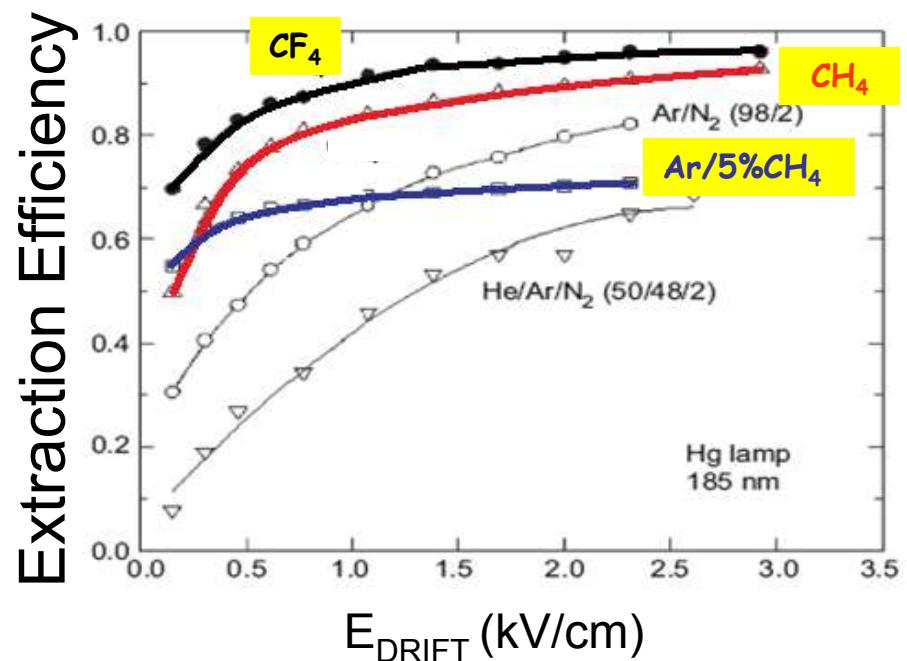
## RICH Requires:

- High E on the PC surface (for  $e^-$ -extraction  $\rightarrow$  high QE).
- Good  $e^-$  focusing into the holes (for high detection efficiency).

# Extraction efficiency w CsI ref. PC



- ) photoelectron extraction increases with  $\text{CH}_4$
- ) very high photoelectron extraction in  $\text{Ne}/10\%\text{CF}_4$  (90%) similar to  $\text{CF}_4$



Breskin & Chechik  
NIMA 595 (2008) 116

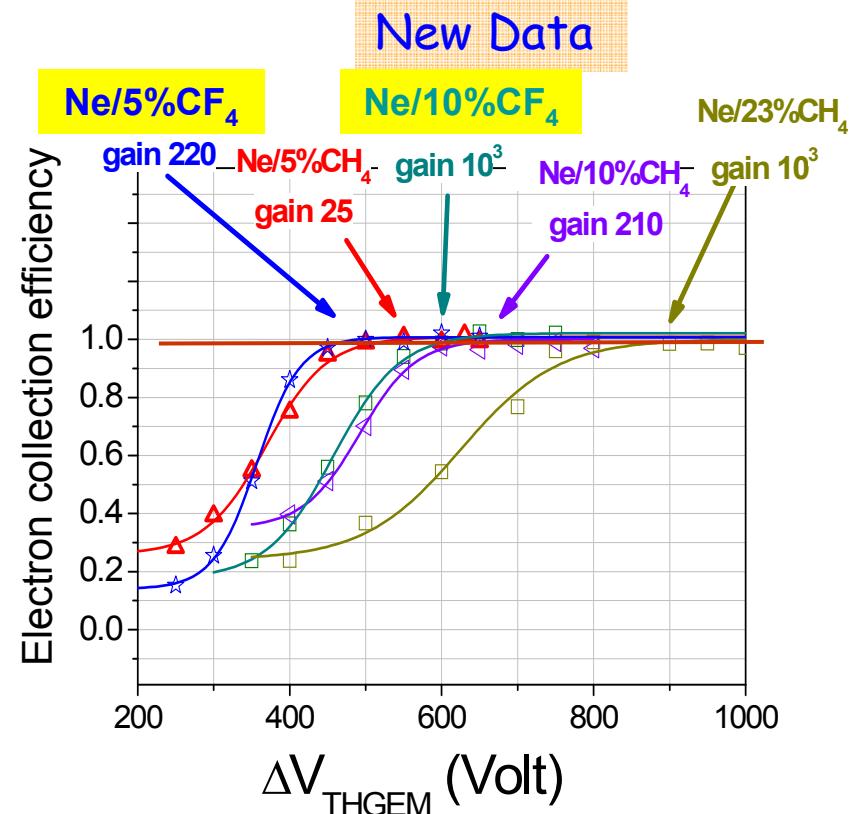
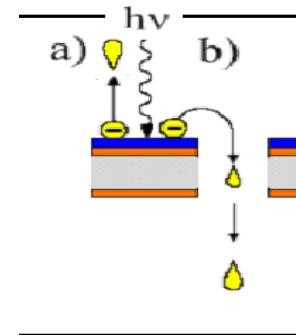
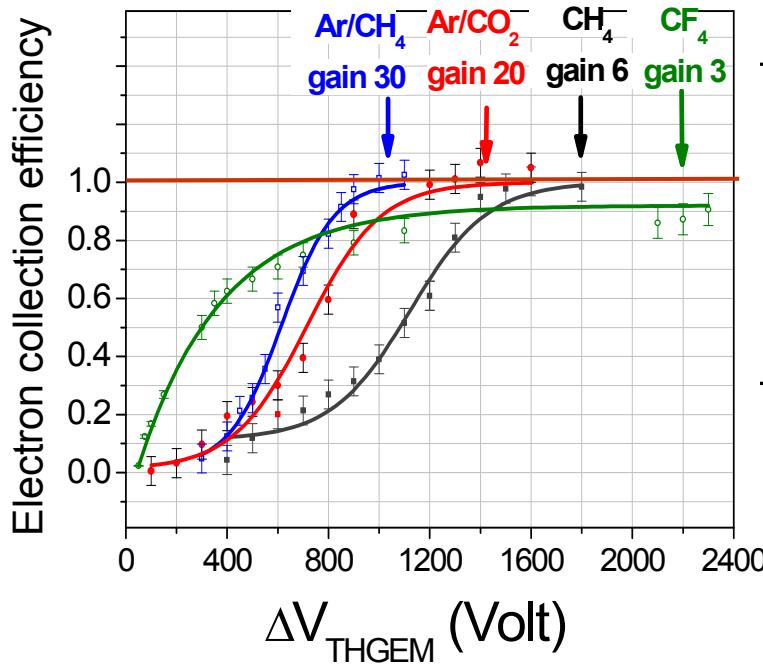
Example: For typical operation voltages in  $\text{Ne}/5\%\text{CH}_4$  ( $E \sim 2.8-3$  kV/cm):  
Effective QE  $\sim 70\%$  (similar to  $\text{Ar}/5\%\text{CH}_4$ !)

# Electron collection efficiency

3x3cm<sup>2</sup> THGEM (thickness = 0.4 mm, hole diameter = 0.3 mm, pitch = 0.7 mm, rim = 0.1 mm)

Method: Pulse-counting of the fraction of single-e<sup>-</sup> events reaching the THGEM bottom

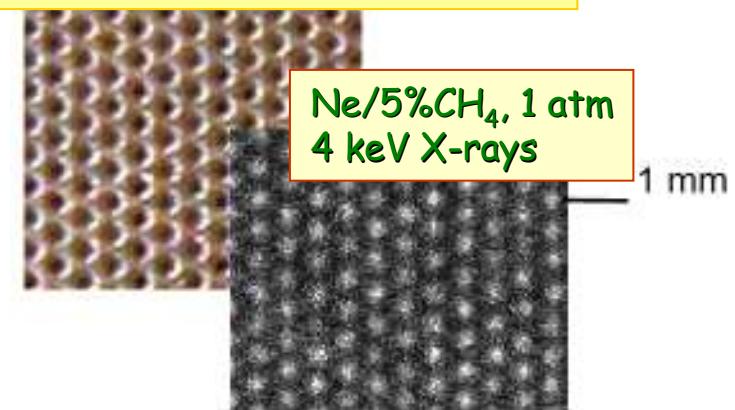
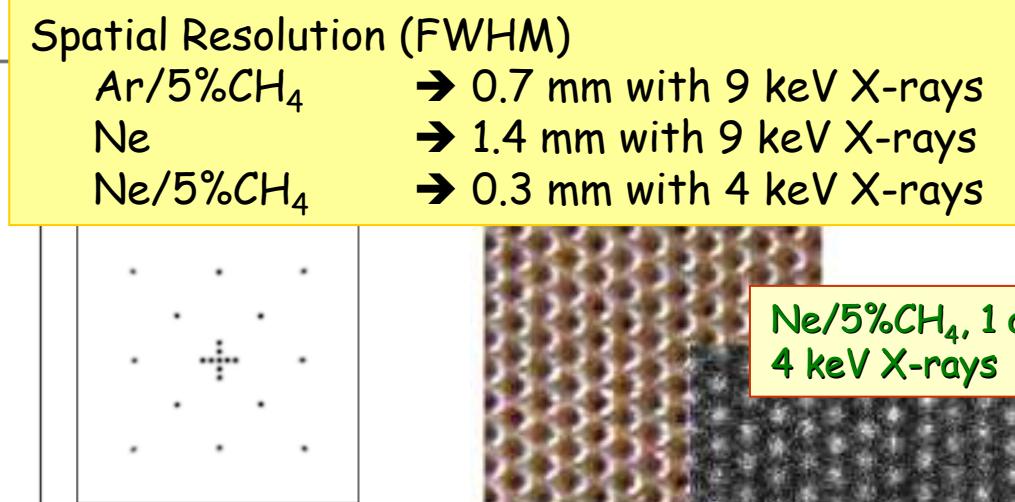
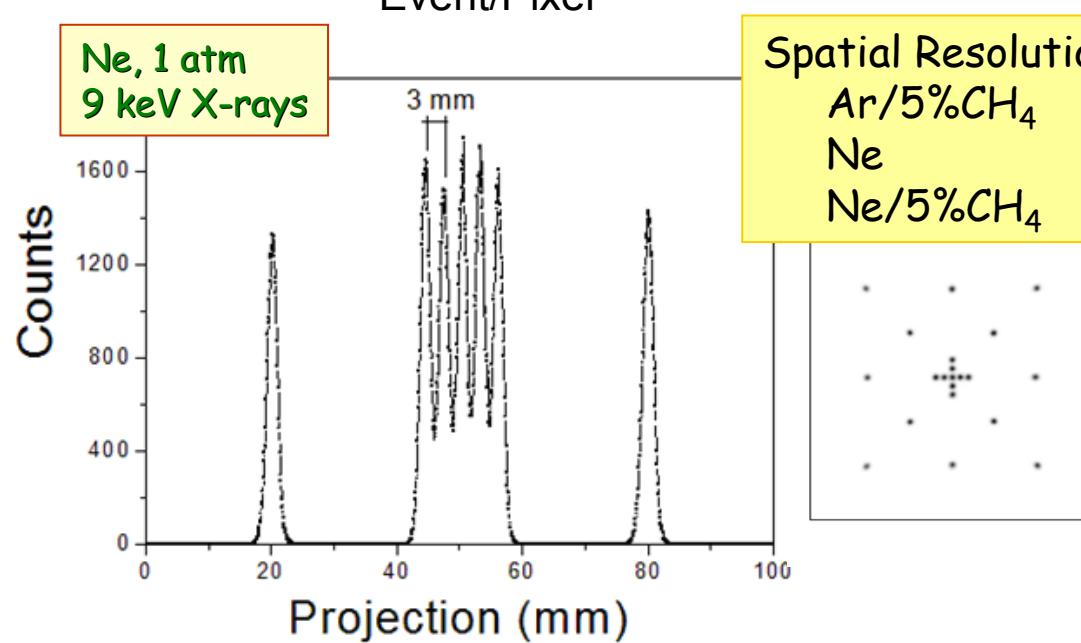
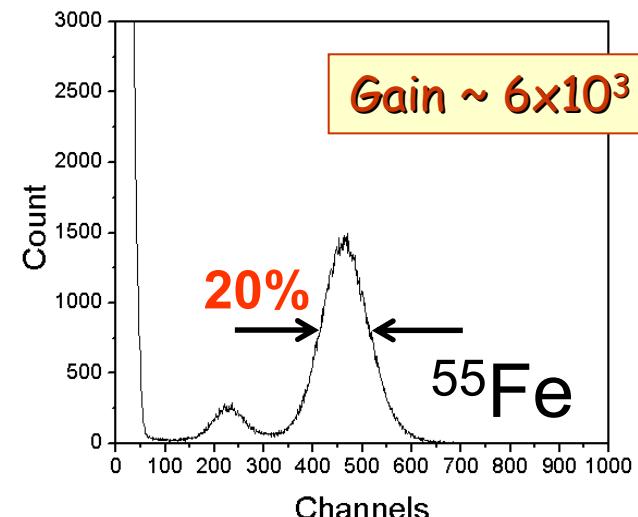
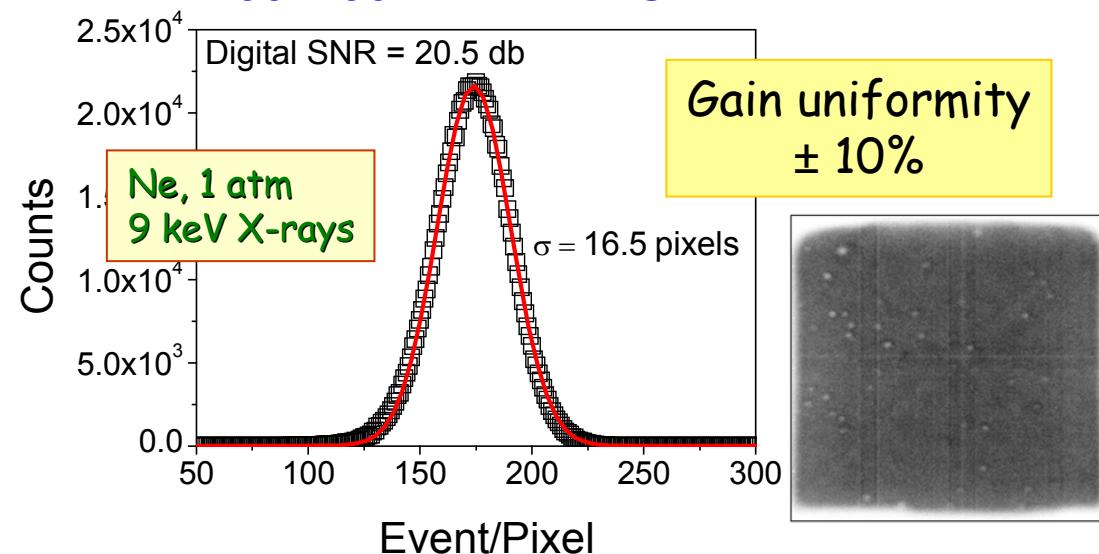
Shalem *et al.* NIMA 558 (2006) 475



THGEM large hole dimensions → efficient e<sup>-</sup> collection into the hole:  
 ↳ full single-e<sup>-</sup> detection efficiency @ gain < 100 (depends on %CH<sub>4</sub>)

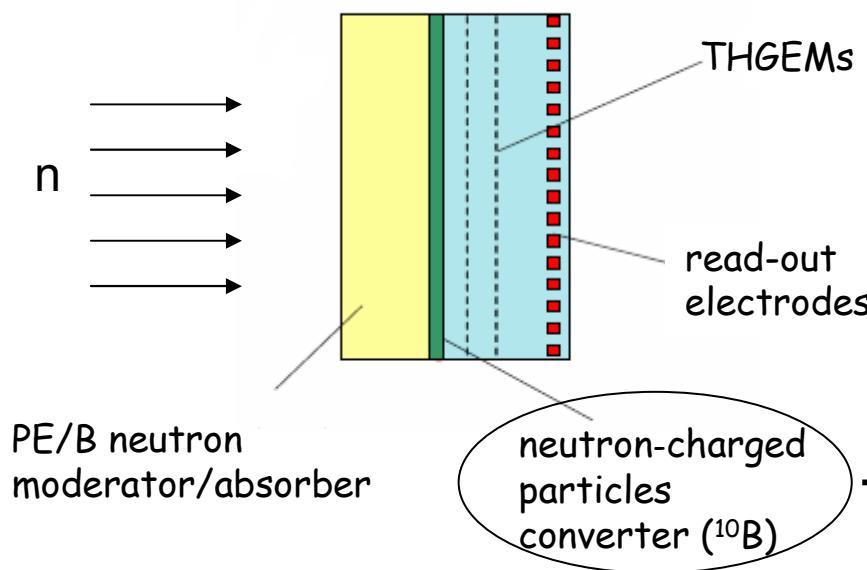
# 2D imaging: results with soft X-rays

100x100 mm<sup>2</sup> D-THGEM



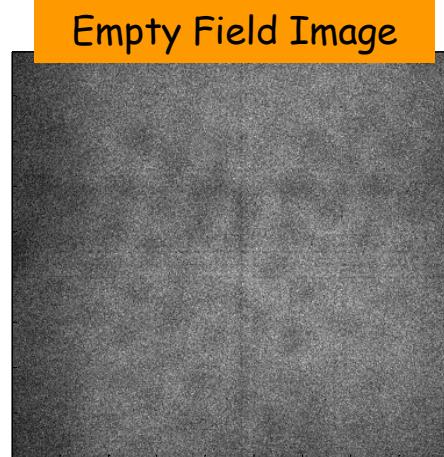
# 2D imaging: results with Neutrons

A fast neutron spectrometer + imaging of flux for BNCT applications



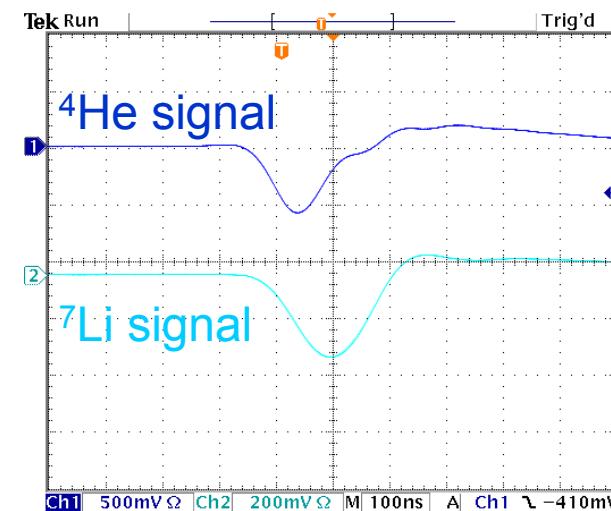
Basic idea:

Bonner-sphere spectroscopy (moderator + thermal neutron detector) in a flat geometry setup with imaging capability



Preliminary data:  
5.9 MeV neutron  
Gain~ $10^4$  in Ne @ n-flux:  
 $\sim 1.6 \cdot 10^5$  n/cm<sup>2</sup>/s

Good Homogeneity &  
Good detector  
stability



# THGEM properties: Summary (1)

## 1) MM-scale dimensions

Economic production ( $10^4$  holes = 300\$)

Versatile geometry & robust (not destroyed by sparks).

Efficient coupling with photocathodes/convertors

Single-electron sensitivity

Rim important for high achievable gain → longer stabilization time (not dramatic)

High-rate capability ( $\sim 10\text{MHz}/\text{mm}^2$  @  $\sim 10^4$  in Ar/CH<sub>4</sub> w single photoelectrons)

Timing: ~10 ns ( $\beta$ , cosmic), ~1-2 ns (multi-photon pulse)

## 2) Large multiplication in Ne, Ne/CH<sub>4</sub> & Ne/CF<sub>4</sub> @ low operation voltages:

- Reduced probability of sparks due to defects and less charging-up
- Large holes diameter → good e-collection already @ low gains (<10<sup>3</sup>)
- Large Dynamic Range (prevent discharge due to high ionizing background)

### Single electron (UV-light)

Single THGEM  $10^{5-6}$ (0.4mm) -  $10^6$ (0.8mm)

Double THGEMs gain  $10^6$ - $10^7$  (0.4mm)

soft x-rays  
Only ~10x lower gain

# THGEM properties: Summary (2)

## 3) UV detectors:

→ Single photon detection: gain  $> 10^6$

(higher gain → more photons per ring)

→ 0.3mm holes/1mm pitch → CsI coverage  $\epsilon_{PC} = 78\text{-}90\%$   
depending on the rim size (0.1-0 mm)

→ CsI QE @ 170 nm = 30%

→ Extraction efficiency in Ne/10%CF<sub>4</sub> →  $\epsilon_{extr} = 90\%$

→ Electron Collection Efficiency →  $\epsilon_{coll} = 100\%$  for gain  $> 10^3$

→ Effective Quantum Efficiency:

$$\underline{QE_{eff} = QE \times \epsilon_{extr} \times \epsilon_{extr} \times \epsilon_{coll} \sim 21\text{-}24\%}$$

Detection efficiency = QE<sub>eff</sub> × electronic-threshold factor (0.8-0.95)

Presently in RICH for COMPASS:

MWPC in CH<sub>4</sub>, typ. gain  $\sim 10^4$ ; Effective Quantum Efficiency (@ 170 nm) ~ 20%

Ongoing: IMAGING test to see if in Ne/CF<sub>4</sub> there are no photon-feedback "satellites"

## 4) Localization resolution (x-rays):

THGEM: 0.5mm holes, 1mm pitch & 2mm readout pitch →

1.4mm FWHM in Ne w. 9keV - 0.3mm FWHM in Ne/5%CH<sub>4</sub> w. 4keV

# Applications

Applications under consideration:

in High Energy Physics, Nuclear Astrophysics, "Exotic Physics"  
(rare events, dark matter), Medical Imaging, n Radiography, etc

## Our ongoing R&D

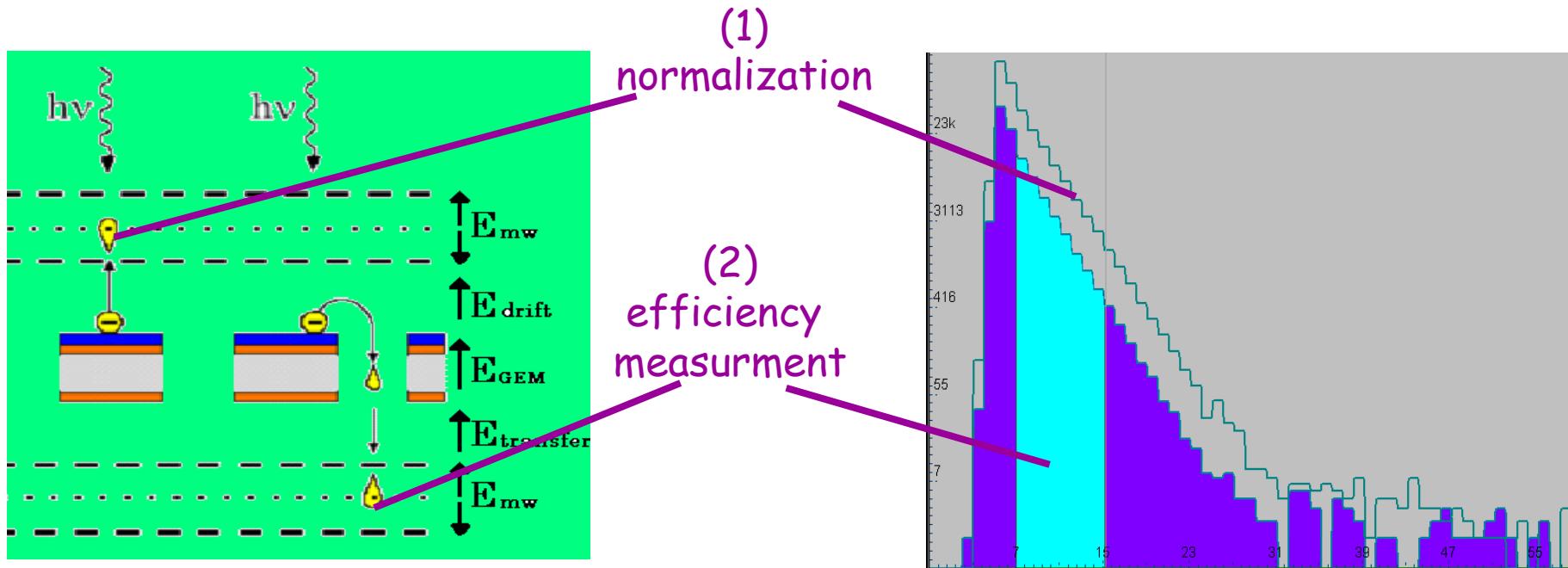
- Economic THGEM production technique & materials  
e.g. CIRLEX (polyimide), TEFLON, KEVLAR, CERAMICs etc.
- Timing/localization with particle beams
- 2-phase mode in noble gases & liquids (w BINP, YALE, Coimbra)
- Cryogenic Gas Photomultiplier for LXe  $\gamma$ -Camera (w Nantes)
- Search for saturated gain mode (with V. Peskov)  
important for single photons and MIPS
- Neutron imaging detectors (with PTB, Milano, Soreq)
- Sampling elements in Digital Hadron Calorimetry  
(with Andy White/Arlington)

# Electron Collection Efficiency

the efficiency to focus an electron into the THGEM  
methodology

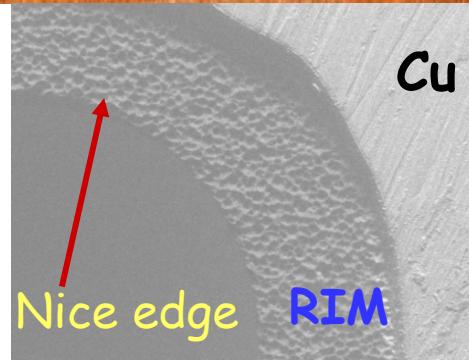
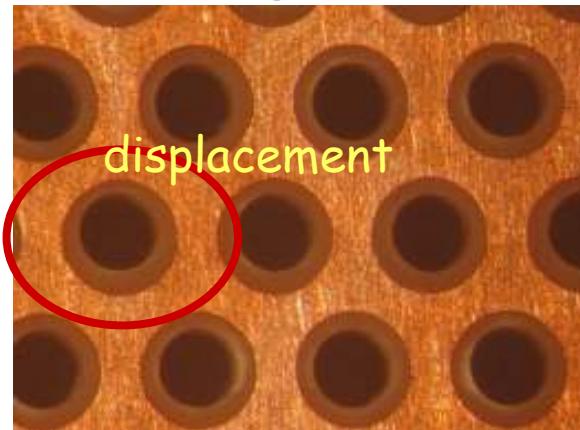
## Pulse counting measurement:

- Based on single  $e^-$  pulses
- Same pc, lamp, gain and electronics, different  $e^-$  path.
- Comparing counting rate provides the fraction of single  $e^-$  events reaching THGEM bottom.

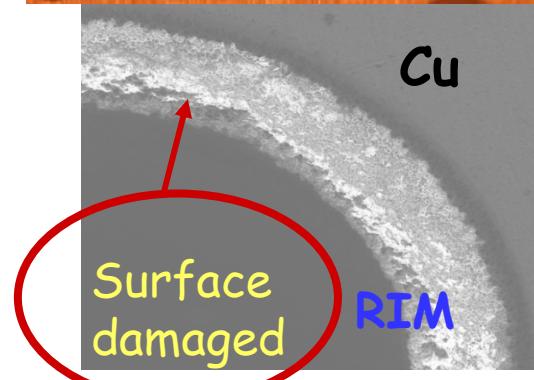
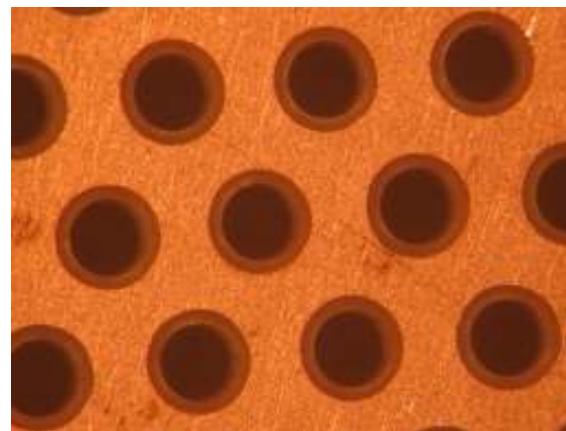


# THGEM production methods

With mask, Weizmann  
Etch w mask + drill  
Large rim



No mask, Weizmann  
Drill + etch under the Cu  
Small and zero rim

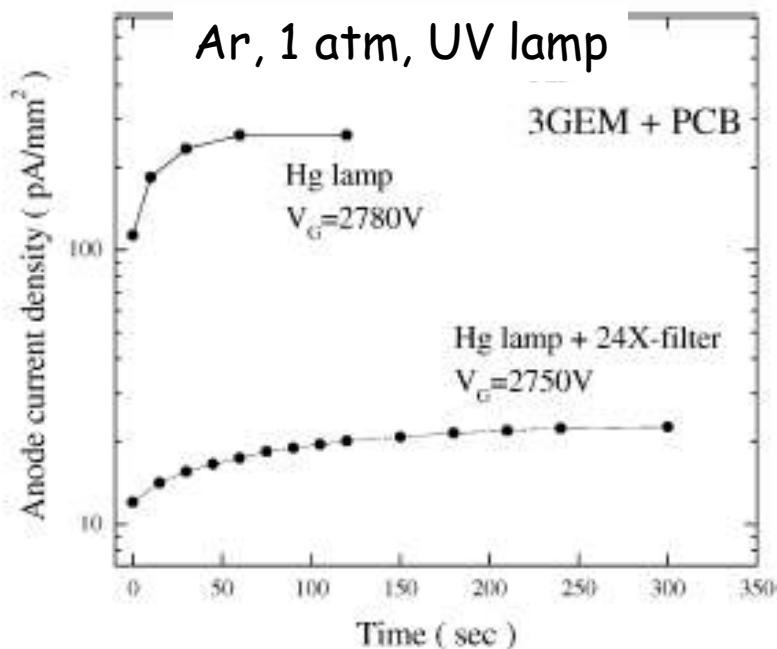


With mask, Eltos, Italy  
Drill + etch w mask  
Large rim

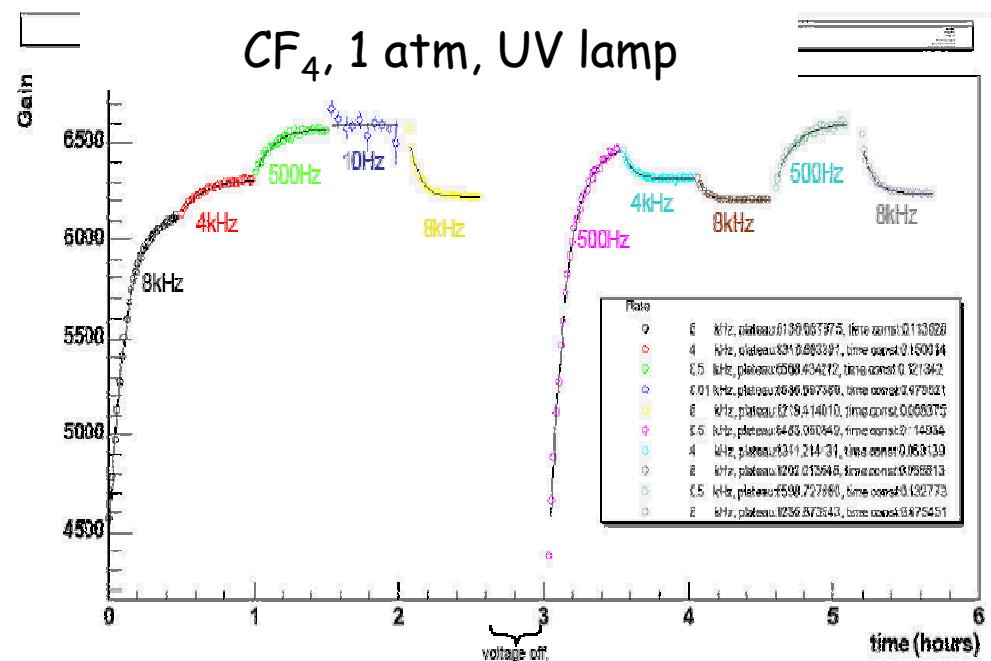


CERN, Zero rim: drill + short etching  
to remove sharp edges from drilling.

## Similar up charging observed in 3-GEM stabilization time 0.5-3 hour

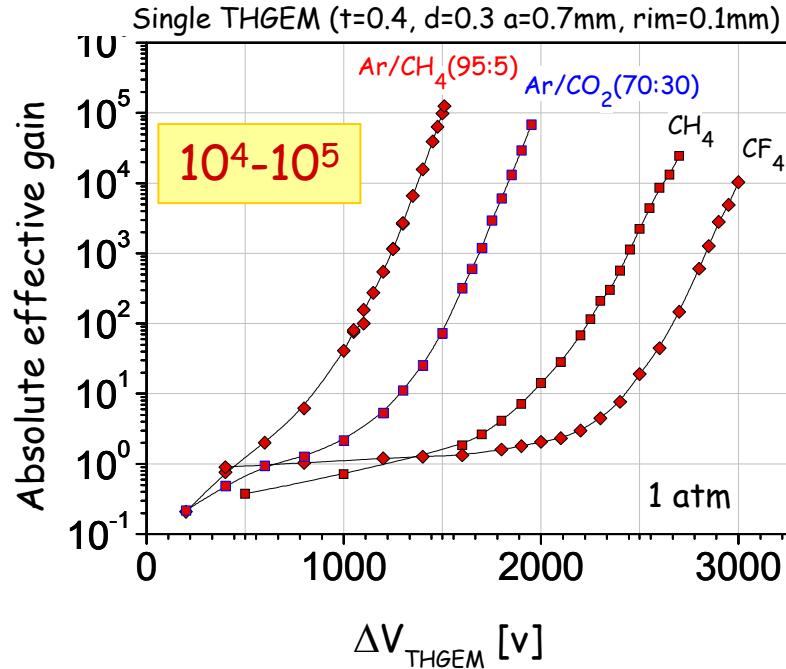


Buzulutskov et al. NIM A442 (2000) 68

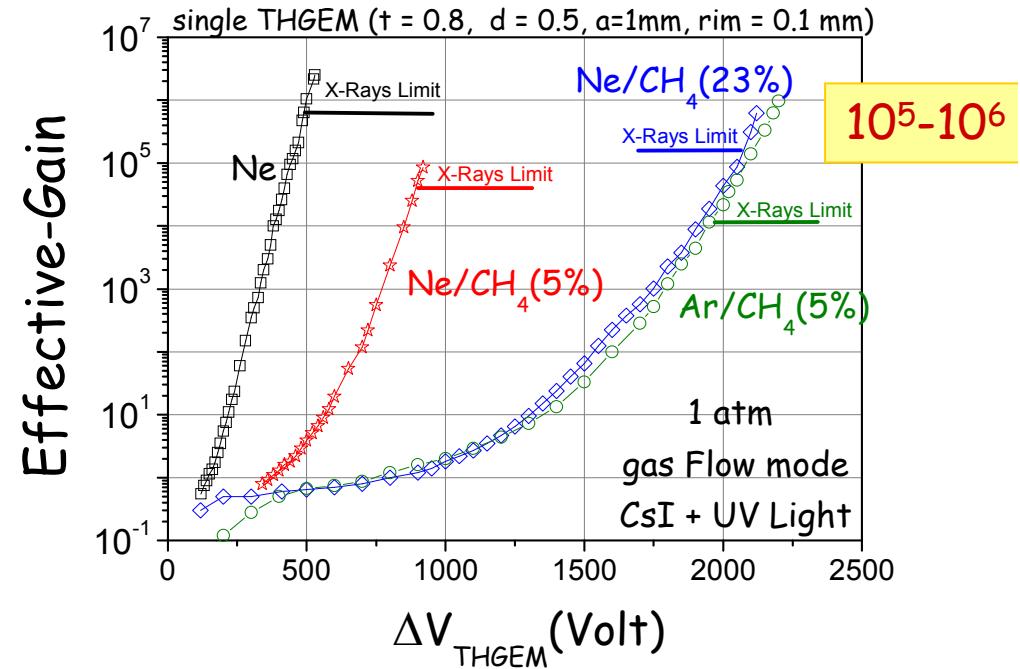


A. Milov et al. J. Phys. G34, S701 2007

# THGEM operation - single THGEM



x100 higher gain  
compared to single GEM



★ Very high gain in 100% Ne and Ne mixtures  
At very low voltages ☺ !!  
100% Ne: Gain  $10^5$  @ <500V  
Lose advantage w increased CH<sub>4</sub> %

# THGEM operation - counting rate

